

General Description

The TS34119 is a low power audio amplifier, it integrated circuit intended (primarily) for telephone applications, such as in speakerphones. It provides differential speaker outputs to maximize output swing at low supply voltages (2.0V minimum). Coupling capacitors to the speaker are not required. Open loop gain is 80dB, and the closed loop gain is set with two external resistors. A chip Disable pin permits powering down and/or muting the input signal. The TS34119 is offered in SOP-8 and DIP-8 package.

Features

- ♦ Wide operating supply voltage (2~16V)
- ♦ Chip disable input to power down the IC
- ♦ Low quiescent current for battery powered application
- ♦ Lower power down quiescent current
- \diamond Drives a wide range of speaker load (8~100 Ω)
- Output power exceed 250mW with 32Ωspeaker
- ♦ Low total harmonic distortion
- ♦ Gain adjustable for voice band
- \diamond Requires few external components

Ordering Information

Part No.	t No. Operating Temp.	
TS34119CD		DIP-8
TS34119CS	-20 ~ +70 °C	SOP-8
TS34119CA		TSSOP-8

Block Diagram Vcc 6 Vin V01 #1 5 FC1 3 4k 4k 50k 125k #2 V02 FC2 8 50k Bias CD Circuit 7 Gnd

Absolute Maximum Rating

Description	Symbol	Value	Unit	
Supply Voltage	Vcc	+1 ~ 18V	V	
Maximum Input Voltage (FC1, FC2, CD, Vin)	Vin	- 1.0 ~ Vcc+1.0	V	
Applied Output Voltage to VO1, VO2 when disabled	Vvo	- 1.0 ~ Vcc+1.0	V	
Maximum Output Current at VO1, VO2	lo	±250	mA	
Storage Temperature Range	T _{STG}	-65 ~ +150	°C	

Note: Maximum ratings are those values beyond which damage to the device may occur, functional operation should be Restricted to the recommended operating conditions.

Recommended Operating Conditions

Description	Symbol	Value	Unit
Supply Voltage	Vcc	+2 ~ 16V	V
Load Impedance	RL	8 ~ 100	Ω
Peak Load Current	IL	200	mA
Differential Gain (5kHz bandwidth)	AVD	0~46	dB
Voltage @ CD (pin 1)	VCD	0 ~ Vcc	v
Operating Temperature, All Package Types	T _{STG}	-10 ~ +70	°C

Note: This device contains protection circuitry to guard against damage due to high static voltage or electric fields. However, precautions must be taken to avoid applications of any voltage higher than maximum rated voltage to this high impedance circuit. For proper operation, Vin and Vout should be constrained to the range Gnd \leq (Vin or Vout) \leq Vcc. Unused inputs must always be tied to an appropriate logic voltage level (e.g., either Gnd or Vcc), unused output must be left open.

Electrical Characteristics (VCD=0V, Ta =25 °C; unless otherwise specified.)

Parameter	Symbol	Test Conditions	Min	Тур	Max	Unit	
Amplifiers (AC Characteristics)							
AC Input Resistance	Ri	@ Vin		>30		MΩ	
Open Loop Gain (Amp. #1)	AVOL1	f<100Hz	80			dB	
Closed Loop Gain (Amp. #2)	AV2	Vcc=6V,f=1KHz, R _L =32Ω	-0.35	0	+0.35	dB	
Gain Bandwidth Product	GBW			1.5		MHz	
Output Power		$Vcc=3V,R_L=16\Omega,THD\leq10\%$	55				
	Pout	$Vcc=6V,R_L=32\Omega,THD\leq10\%$	250		-	mW	
		$Vcc=12V,R_L=100\Omega,THD\leq10\%$	400				
Total Harmonic Distortion		Vcc=6V, R_L =32 Ω , Po=125mW		0.5	1.0		
(f=1KHz)	THD	Vcc≥3V, R _L =8Ω, Po=20mW		0.5		%	
		Vcc≥12V, R _L =32Ω, Po=200mW		0.6			
Power Supply Rejection		C1=∞, C2=0.01uF	50		-		
(Vcc=6.0V, ∆Vcc=3.0V)	PSRR	C1=0.1uF, C2=0, f=1KHz		12		dB	
		C1=1uF, C2=5uF, f=1KHz		52	-		
Differential Muting	GMT	$Vcc\text{=}6V, \ 1KHz \leq f \leq 20KHz,$		>70		dB	
		CD=2V					

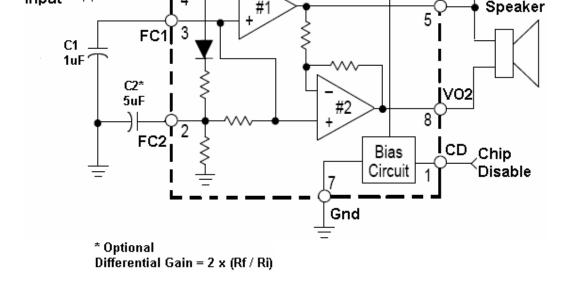


Electrical Characteristics (VCD=0V, Ta =25 °C; unless otherwise specified.)						
Parameter	Symbol	Test Conditions	Min	Тур	Max	Unit
Amplifiers (DC Characteristics	5)					
Output DC Level @ VO1,VO2		V _{CC} =3V, RL=16 (R _f =75K)	1.0	1.15	1.25	
	Vo	Vcc=6V, RL=16 (R _f =75K)		2.65		Vdc
		Vcc=12V, RL=16 (R _f =75K)		5.56		
Output Level	V _{OH}	lout=-75mA, $2.0 \le Vcc \le 16V$	V	/cc-1.0 (typ)	Vdc
	V _{OL}	lout=75mA, $2.0 \le Vcc \le 16V$		0.16		
Output DC Offset Voltage	ΔVo	Vcc=6V, RL=75K Ω , R _L =32 Ω	-30	0	+30	mV
(VO1 – VO2)			_			
Input Bias Current @ Vin	f _{IB}	Vcc=6.0V		-100	-200	nA
Equivalent Resistance @ FC1	R _{FC1}	Vcc=6.0V	100	150	220	ΚΩ
Equivalent Resistance @ FC2	R _{FC2}		18	25	40	
Chip Disable (pin 1)						
Input Voltage Low	VIL				0.8	Vdc
Input Voltage High	V _{IH}		2.0			
Power Supply						
Power Supply Current		Vcc=3V, R _L =∞, CD=0.8V		2.7	4.0	mA
	lcc	Vcc=16V, R _L =∞, CD=0.8V		3.3	5.0	
		Vcc=3V, R _L =∞, CD=2V		65	100	uA
Note: Currents into a pin are pos	sitive, currei	nts out of a pin negative.				
Typical Temperature P	erforma	nce (-10 °C < Ta < +70 °C)				
Function	Condition		Typical Change		• L	Inits
Input Bias Current	@ Vin		±40		Р	a / ⁰C
Total Harmonic Distortion	Vcc=6V, I	R _L =32Ω, Po=120mW, f=1kHz	+0.003		%	‰ / °C
Power Supply Current	Vcc=3V, R _L =∞, CD=0V		-2.5		u	A / ⁰C
	Vcc=3V, I	R _L =∞, CD=2V	-	0.03		

Downloaded from **Elcodis.com** electronic components distributor



Symbol	Pin	Description			
	1	Chip Disable-Digital input. A logic "0" (<0.8V) sets normal operation. A logic "I" (≥2.0V) set			
CD	CD 1 the power down mode. Input impedance is nominally 90KΩ				
FC2 2 A capacitor at this pin increases power supply rejection, and affects turn-on					
FGZ	2	can be left open it the capacitor at FC1 is sufficient.			
		Analog ground for the amplifiers. A 1uF capacitor at this pin (with a 5uF capacitor at pin 2)			
FC1	3	provides 52dB(typically) of power supply rejection. Turn-on time of the circuit is affected by			
		the capacitor on this pin. This pin can be used as an alternate input.			
Vin	4	Amplifier input. The input capacitor and resistor set low frequency roll off and input			
VIII	4	impedance. The feedback resistor is connected to this pin and VO1.			
VO1	5	Amplifier Output #1. The dc level is \approx (V _{CC} - 0.7) / 2			
V _{CC}	6	DC supply voltage (+2.0V ~ +16V) is applied to this pin.			
GND	7	Ground pin for the entire circuit.			
VO2	8	Amplifier Output #2. This signal is equal in amplitude, but 180° out-of-phase with that at			
V02	0	VO1. The dc level is \approx (V_{CC} - 0.7V) / 2.			
ypical A	pplicatio	on Circuit			
Aud Inpu	0.1 غ مرا ل_ io	Rf 75k Vcc 6 Vin 4 4 +1 +1 5 1 4 4 +1 4 +1			





Design Guideline

GENERAL

The TS34119 is a low power audio amplifier capable of low voltage operation (Vcc=2.0V minimum) such as that encountered in line-powered speakerphones. The circuit provides a differential output (VO1-VO2) to the speaker to maximize the available voltage swing at low voltages. The different gain is set by two external resistors. Pins FC1 and FC2 allow controlling the amount of power supply and noise rejection, as well as providing alternate inputs to the amplifiers. The CD pin permits powering down the IC for muting purposes and to conserve power.

AMPLIFIERS

Referring to the block diagram, the internal configuration consists of two identical operational amplifiers. Amplifier #1 has an open loop gain of \geq 80Db (at f \leq 100Hz), and the closed loop gain is set by external resistor Rf and Rj. The amplifier is unity gain stable, and has a unity gain frequency of approximately 1.5MHz. In order to adequately cover the telephone voice band (300Hz to 3.4kHz), a maximum closed loop gain of 46dB is recommended. Amplifier #2 is internally set to gain of –1.0 (0dB). The outputs of both amplifiers are capable of souring and sinking a peak current of 200mA. The outputs can typically swing to within \approx 0.4V above ground, and to within \approx 1.3V below V_{CC}, at the maximum current. See Figure 18 and 19 for V_{OH} and V_{OL} curves.

The output dc offset voltage (VO1-VO2) is primarily a function of the feedback resistor (R_f), and secondarily due to the amplifiers' input offset voltages. The input offset voltage of the two amplifiers will generally be similar for a particular IC, and therefore nearly cancel each other at the outputs. Amplifier #1's bias current, however, flows out of Vin (pin 4) and through R_f , forcing VO1 to shift negative by an amount equal to ($R_f \times I_{IB}$), Vo2 is shifted posited an equal amount. The output offset voltage, specified in the Electrical Characteristics is measured with the feedback the feedback resistor shown in the Typical Application Circuit, and therefore takes into account the bias current as wells internal offset voltages of the amplifiers. The bias current is constant with respect to V_{CC} .

FC1 AND FC2

Power supply rejection is provided by the capacitors (C1 and C2 in the typical Application Circuit) at FC1 and FC2. C2 is somewhat dominant at low frequencies, while C1 is dominant at high frequencies, as shown in the graphs of Figure 4 to 7. The required values of C1 and C2 depend on the conditions of each application. A line powered speakerphone, for example, will require more filtering than a circuit powered by a well regulated power supply. The amount of rejection is function of the capacitors, and the equivalent impedance looking into FC1 and FC2 (listed in the Electrical Characteristics as R_{FC1} and R_{FC2}). In addition to providing filtering, C1 and C2 also affect the turn-on time of the circuit at power-up, since the two capacitors must charge up through the internal 50K and 125K resistors. The graph of Figure 1 indicates the turn-on time upon application of V_{CC} of +6V. The turn-on time is \approx 60% longer for V_{CC} =3V, and \approx 20% less for V_{CC} =9V. Turn-off time is <10uS upon removal of V_{CC}.

CHIP DISABLE

The chip Disable (pin 1) can be used to power down the IC to conserve power, or for muting, or both. When at a Logic "0" (0V to 0.8V), the TS34119 is enabled for normal operation. When pin 1 is a Logic "1" (2V to V_{CC}), the IC is disabled. If pin 1 is open, that is equivalent to Logic "0" although good design proactive dictates that an input should never be left open. Input impedance at pin 1 is a nominal 90K Ω . The power supply current (when disabled) is shown in Figure 15.

Muting, defined as the change in differential gain from normal operation to muted operation, is in excess of 70dB. The turn-off time the audio output, from the application of the CD signal, is <2uS, and turn on-time is 12 mS-15mS. Both times are independent of C1, C2, and V_{CC}. When the TS34119 is disabled, the voltage at FC1 and FC2 do not change as they are powered from Vcc. The outputs, VO1 and VO2, change to high impedance condition, removing the signal from the speaker. If signals from other sources are to be applied to the outputs (while disabled), they must be within the range of V_{CC} and Ground.

LAYOUT CONSIDERATIONS

Normally a snobbier is not needed at the output of the TS34119, unlike many other audio amplifiers, However, the PC board layout, stray capacitances, and the manner in which the speaker wires are configured, may dictate otherwise. Generally, the speaker wires should be twisted tightly, and not more than a few inches in length.



Design Guideline

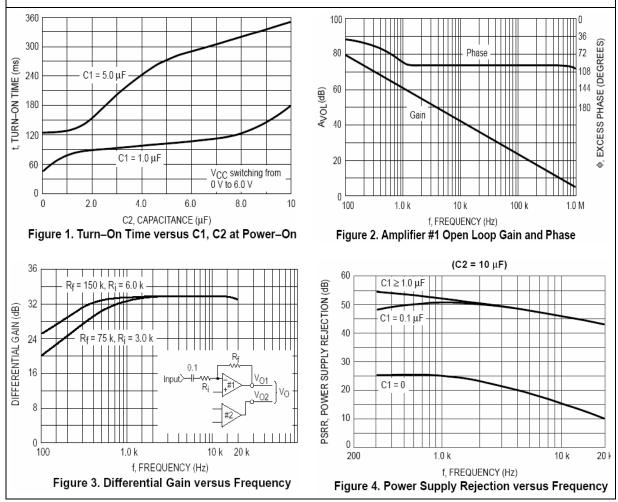
POWER DISSIPATION

Figure 8 to 10 indicate the device dissipation (within the IC) for various combinations of V_{CC}, R_L, and load power. The maximum power which can safely be dissipated within the TS34119 is found from the following equation: P_D = (140°C - Ta) / Θ ja

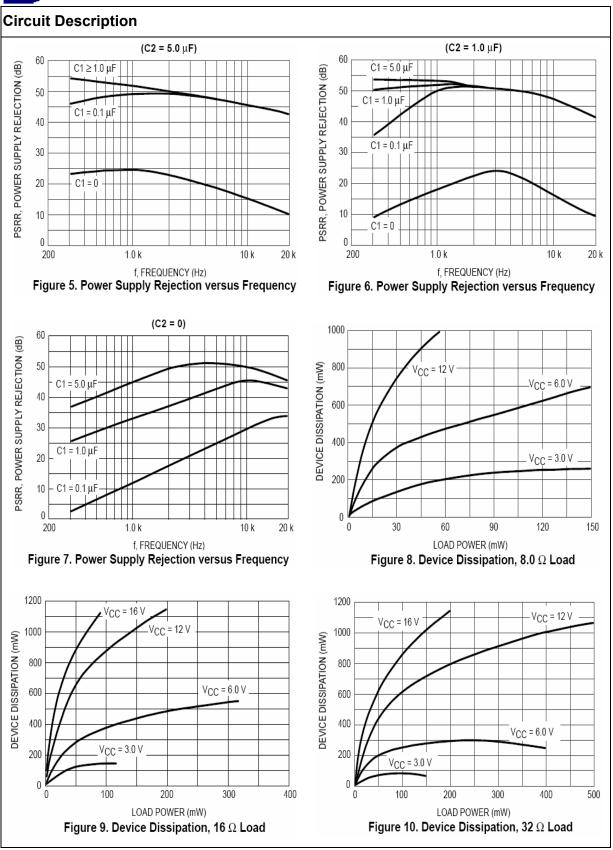
Where Ta is the ambient temperature; and Θ_{ja} is the package thermal resistance (100 °C / W for the standard DIP package, and 180 °C / W for the surface mount package.) The power dissipated within the TS34119, in a given application, it is found from the following equation: $P_D = (V_{CC} \times I_{CC}) + (I_{RMS} \times V_{CC}) - (RL \times I_{RMS}^2)$

Where I_{CC} is obtained from Figure 15; and I_{RMS} is the RMS current at the load; and RL is load resistance. Figure 8 to 10, along with Figure 11 to 13 (distortion curves), and a peak working load current of ±200mA, define the operating range for the TS34119. The operating range is further defined in terms of allowable load power in Figure 14 for loads of 8Ω , 16Ω and 32Ω . The left (ascending) portion of each of the three curves is defined by the power level at which 10% distortion occurs. The center flat portion of each curve is defined by the maximum output current capability of the TS34119. The right (descending) portion of each curve is defined by the maximum internal power dissipation of the IC at 25 °C. At higher ambient temperatures, the maximum load power must be reduced according to the above equations. Operating the device beyond the current and junction temperature limits will degrade long-term reliability.

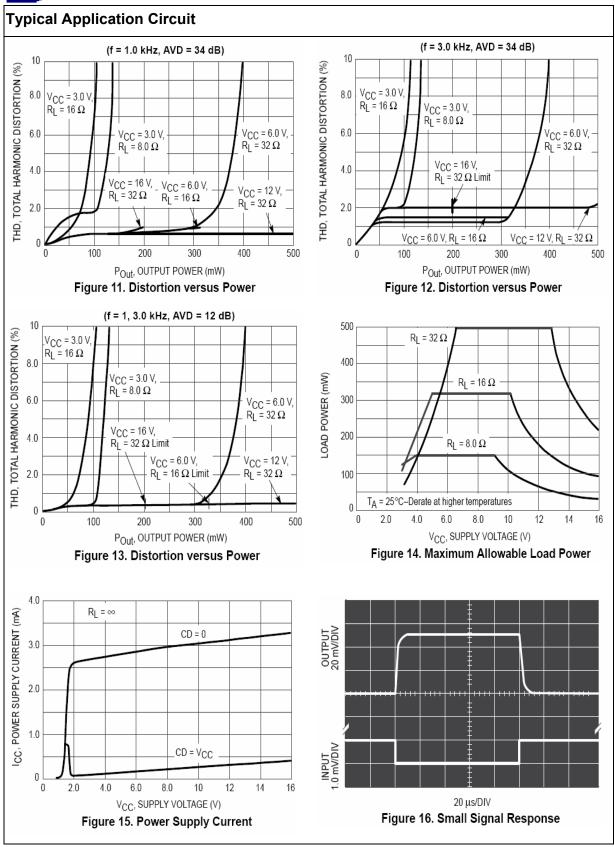
Circuit Description



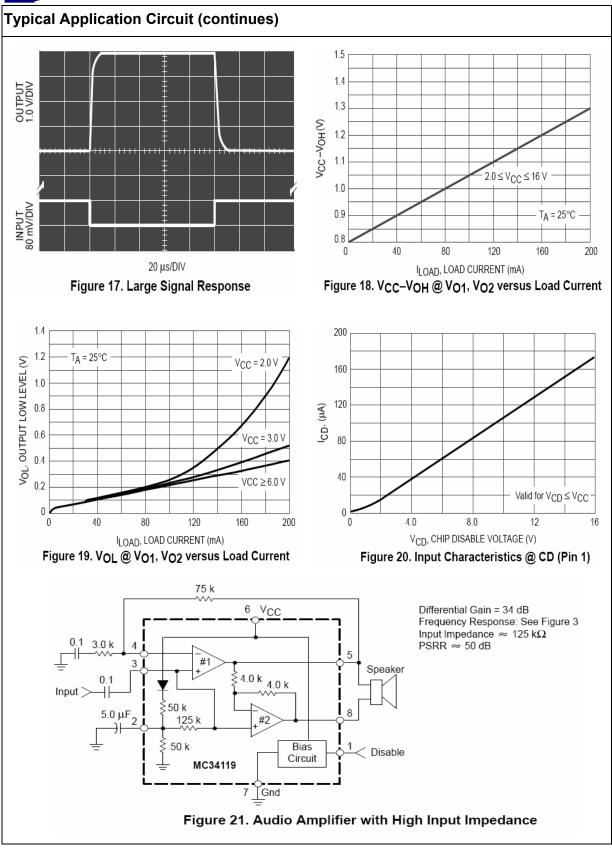




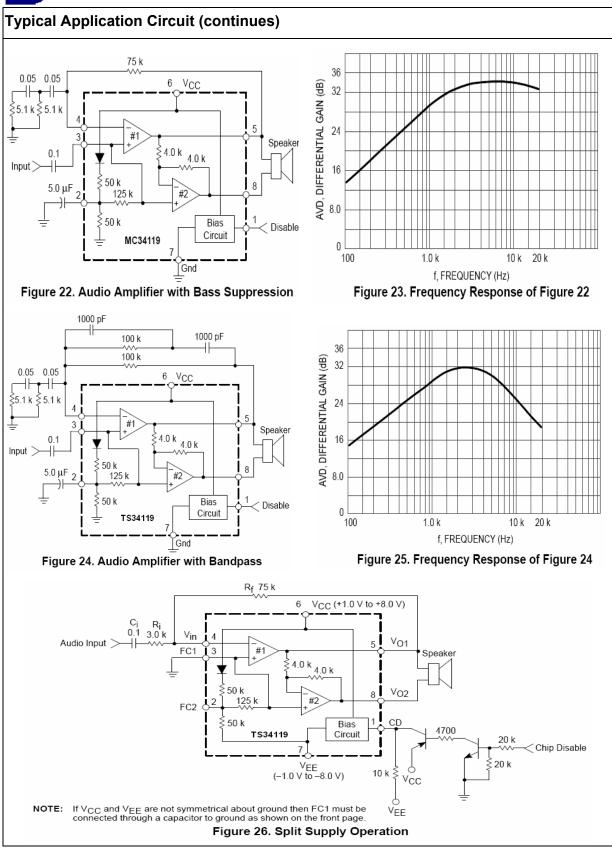






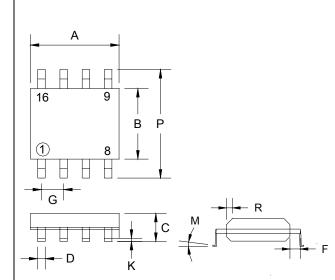






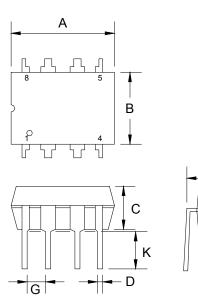


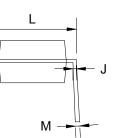
SOP-8 Mechanical Drawing



	SOP-8 DIMENSION					
DIM	MILLIMETERS		INCHES			
DIN	MIN	MAX	MIN	MAX		
А	4.80	5.00	0.189	0.196		
В	3.80	4.00	0.150	0.157		
С	1.35	1.75	0.054	0.068		
D	0.35	0.49	0.014	0.019		
F	0.40	1.25	0.016	0.049		
G	1.27	1.27 (typ)		(typ)		
К	0.10	0.25	0.004	0.009		
М	0°	7°	0°	7°		
Р	5.80	6.20	0.229	0.244		
R	0.25	0.50	0.010	0.019		

DIP-8 Mechanical Drawing





	DIP-8 DIMENSION				
DIM	MILLIMETERS		INCHES		
DIN	MIN	MAX	MIN	MAX	
А	9.07	9.32	0.357	0.367	
В	6.22	6.48	0.245	0.255	
С	3.18	4.45	0.125	0.135	
D	0.35	0.55	0.019	0.020	
G	2.54 (typ)		yp) 0.10 (typ)		
J	0.29	0.31	0.011	0.012	
К	3.25	3.35	0.128	0.132	
L	7.75	8.00	0.305	0.315	
М	-	10 [°]	-	10°	